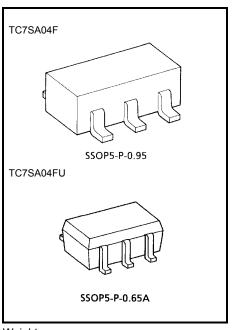
TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7SA04F,TC7SA04FU

Inverter

Features

- Low voltage operation : V_{CC} = 1.8~3.6 V
- High speed operation : t_{pd} = 2.8 ns (max) (V_{CC} = 3.0~3.6 V)
- : t_{pd} = 3.7 ns (max) (V_{CC} = 2.3~2.7 V)
 - : t_{pd} = 7.4 ns (max) (V_{CC} = 1.8 V)
- High Output current $: I_{OH}/I_{OL} = \pm 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
 - : I_{OH}/I_{OL} = ±18 mA (min) (V_{CC} = 2.3 V)
 - $: I_{OH}/I_{OL} = \pm 6 \text{ mA} (\text{min}) (V_{CC} = 1.8 \text{ V})$
- 3.6-V tolerant input
- 3.6-V power down protection output
- TC74VCX04FT equivalent



Weight SSOP5-P-0.95 : 0.016 g (typ.) SSOP5-P-0.65A : 0.006 g (typ.)

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V _{CC}	-0.5~4.6	V	
DC input voltage	VIN	-0.5~4.6	V	
DC output voltage	Vout	-0.5~4.6 (Note 1)	V	
De oulput voltage	VOUI	-0.5~V _{CC} + 0.5 (Note 2)	v	
Input diode current	I _{IK}	-50	mA	
Output diode current	lok	-50 (Note 3)	mA	
DC output current	IOUT	±50	mA	
Power dissipation	PD	200	mW	
DC V _{CC} /ground current	ICC	±100	mA	
Storage temperature range	T _{stg}	-65~150	°C	

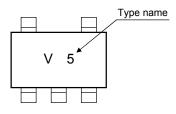
Note 1: V_{CC} = 0 V

Note 2: High or low state. I_{OUT} absolute maximum rating must be observed.

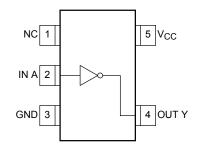
Note 3: V_{OUT} < GND

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Marking



Pin Assignment (top view)



Logic Diagram



А	Y
L	Н
Н	L

Truth Table

Recommended Operating Range

Characteristics	Symbol	Rating	Unit	
Dowor oupply voltage	Vee	1.8~3.6	V	
Power supply voltage	Vcc	1.2~3.6 (Note 4)	v	
Input voltage	V _{IN}	-0.3~3.6	V	
Output voltage	V _{OUT}	0~3.6 (Note 5)	V	
Output voltage		0~V _{CC} (Note 6)	v	
		±24 (Note 7)		
Output current	I _{OH} /I _{OL}	±18 (Note 8)	mA	
		±6 (Note 9)		
Operating temperature range	T _{opr}	-40~85	°C	
Input rise and fall time	dt/dv	0~10 (Note 10)	ns/V	

Note 4: Data retention only

Note 5: $V_{CC} = 0 V$

Note 6: High or low state

Note 7: $V_{CC} = 3.0 \sim 3.6 \text{ V}$

Note 8: V_{CC} = 2.3~2.7 V

Note 9: $V_{CC} = 1.8 V$

Note 10: $V_{IN} = 0.8 \text{--} 2.0 \text{ V}, \text{ } V_{CC} = 3.0 \text{ V}$

Electrical Characteristics

DC Characteristics (Ta = -40~85°C, 2.7 V < V_{CC} \leq 3.6 V)

Chara	otoristics	Symbol	Tor	st Condition		Min	Max	Unit
Characteristics		Symbol	163	SCONDITION	V _{CC} (V)	IVIIII	IVIAX	Unit
Input voltage	High level	V _{IH}		_	2.7~3.6	2.0	_	v
input voltage	Low level	VIL		_	2.7~3.6	_	0.8	v
			I _{OH} = -100 μA	2.7~3.6	V _{CC} - 0.2	_		
	High level	V _{OH}	$V_{IN} = V_{IL}$	I _{OH} = -12 mA	2.7	2.2	_	V
	_			I _{OH} = -18 mA	3.0	2.4	_	
Output voltage				I _{OH} = -24 mA	3.0	2.2	_	
		V _{OL}	$V_{IN} = V_{IH}$	I _{OL} = 100 μA	2.7~3.6	_	0.2	
	Low level			$I_{OL} = 12 \text{ mA}$	2.7	_	0.4	
	Low level			I _{OL} = 18 mA	3.0	_	0.4	
				I _{OL} = 24 mA	3.0	_	0.55	
Input leakage curr	ent	I _{IN}	V _{IN} = 0~3.6 V		2.7~3.6	_	±5.0	μA
Power off leakage	current	I _{OFF}	$V_{IN}, V_{OUT} = 0$	~3.6 V	0	_	10.0	μA
Quiescent supply current		laa	$V_{IN} = V_{CC}$ or C	$V_{IN} = V_{CC} \text{ or } GND$		_	20.0	
		ICC	$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 \text{ V}$		2.7~3.6	_	±20.0	μA
Increase in I _{CC} pe	r input	Δlcc	$V_{IH} = V_{CC} - 0.$	6 V	2.7~3.6	_	750	

DC Characteristics (Ta = -40~85°C, 2.3 V \leq V_{CC} \leq 2.7 V)

Characteristics		Symbol Test Condition			Min	Max	Unit	
					V _{CC} (V)			
Input voltage	High level	VIH		—	2.3~2.7	1.6	_	v
input voltage	Low level	VIL		—	2.3~2.7		0.7	v
			$I_{OH} = -100 \ \mu A$	2.3~2.7	V _{CC} - 0.2			
	High level	V _{OH}	$V_{IN} = V_{IL}$	$I_{OH} = -6 \text{ mA}$	2.3	2.0	_	V
Output voltage				$I_{OH} = -12 \text{ mA}$	2.3	1.8		
				I _{OH} = -18 mA	2.3	1.7		
		el V _{OL}	$V_{IN} = V_{IH}$	$I_{OL} = 100 \ \mu A$	2.3~2.7		0.2	
	Low level			$I_{OL} = 12 \text{ mA}$	2.3		0.4	
				I _{OL} = 18 mA	2.3		0.6	
Input leakage curr	ent	I _{IN}	V _{IN} = 0~3.6 V		2.3~2.7		±5.0	μA
Power off leakage	current	IOFF	V _{IN} , V _{OUT} = 0~3.6 V		0	_	10.0	μA
		Icc	$V_{IN} = V_{CC}$ or ($V_{IN} = V_{CC}$ or GND		_	20.0	μA
Quiescent supply of	Quiescent supply current		$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 \text{ V}$		2.3~2.7	_	±20.0	

DC Characteristics (Ta = -40~85°C, 1.8 V \leq V_{CC} < 2.3 V)

Characteristics		Symbol Test Condition		andition		Min	Мах	Unit
		Symbol	rest c	Test Condition		IVIIII	Wax	Unit
Input voltage	High level	V _{IH}		_	1.8~2.3	$0.7 \times V_{CC}$	_	V
input voltage	Low level	V _{IL}	_		1.8~2.3		$0.2 \times V_{CC}$	v
High level	Vон	V _{IN} = V _{II}	I _{OH} = -100 μA	1.8	V _{CC} - 0.2	_		
	-	-		I _{OH} = -6 mA	1.8	1.4	_	V
	Low level	el V _{OL}	$V_{IN} = V_{IH}$	$I_{OL} = 100 \ \mu A$	1.8	_	0.2	
	Low level			$I_{OL} = 6 \text{ mA}$	1.8	_	0.3	
Input leakage curre	ent	I _{IN}	$V_{IN} = 0~3.6 V$		1.8	_	±5.0	μA
Power off leakage	current	I _{OFF}	$V_{IN}, V_{OUT} = 0 \sim 3.$	6 V	0	_	10.0	μA
Quiescent supply current			$V_{IN} = V_{CC}$ or GND		1.8	_	20.0	
Quiescent supply (Junent	Icc	$V_{CC} \leqq (V_{IN}, V_{OUT}) \leqq 3.6 \text{ V}$		1.8		±20.0	μA

AC Characteristics (Ta = -40~85°C, input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF, $R_L = 500 \Omega$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{pLH} t _{pHL}	Figure 1, Figure 2	1.8	1.0	7.4	
			2.5 ± 0.2	0.8	3.7	ns
			$\textbf{3.3}\pm\textbf{0.3}$	0.6	2.8	

For $C_L = 50 \text{ pF}$, add approximately 300 ps to the AC maximum specification.

Dynamic Switching Characteristics (Ta = 25° C, input: t_r = t_f = 2.0 ns, C_L = 30 pF)

Characteristics	Symbol	Test Condition			Тур.	Unit
	,			$V_{CC}\left(V\right)$,,	
		$V_{IN} = 1.8 V, V_{IL} = 0 V$	(Note 11)	1.8	0.25	
Quiet output maximum dynamic V_{OL}	V _{OLP}	$V_{IN}=2.5~V,~V_{IL}=0~V$	(Note 11)	2.5	0.6	ns
		$V_{IN} = 3.3 V, V_{IL} = 0 V$	(Note 11)	3.3	0.8	
		$V_{IN} = 1.8 V, V_{IL} = 0 V$	(Note 11)	1.8	-0.25	ns
Quiet output minimum dynamic V_{OL}	V _{OLV}	$V_{IN} = 2.5 V, V_{IL} = 0 V$	(Note 11)	2.5	-0.6	
		$V_{IN} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	(Note 11)	3.3	-0.8	
		$V_{IN} = 1.8 V, V_{IL} = 0 V$	(Note 11)	1.8	1.5	
Quiet output minimum dynamic V _{OH}	V _{OHV}	$V_{IN} = 2.5 \text{ V}, \text{ V}_{IL} = 0 \text{ V}$	(Note 11)	2.5	1.9	ns
		$V_{IN} = 3.3 V, V_{IL} = 0 V$	(Note 11)	3.3	2.2	

Note 11: Parameter guaranteed by design.

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}	—		1.8, 2.5, 3.3	5	pF
Power dissipation capacitance	CPD	f _{IN} = 10 MHz	(Note 12)	1.8, 2.5, 3.3	18	pF

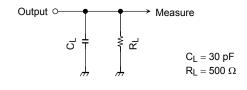
Note 12: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation.

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

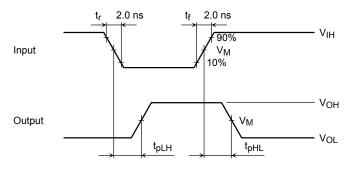
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AC Test Circuit

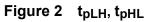




AC Waveforms



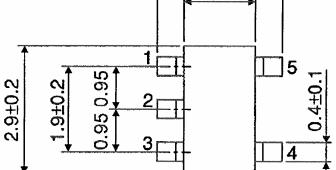
Symbol		V _{CC}					
Symbol	$3.3\pm0.3\;V$	$2.5\pm0.2~\text{V}$	1.8 V				
VIH	2.7 V	V _{CC}	V _{CC}				
VM	1.5 V	V _{CC} /2	V _{CC} /2				

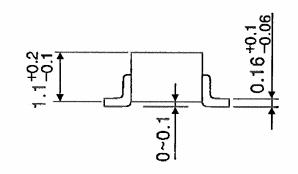


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Package Dimensions



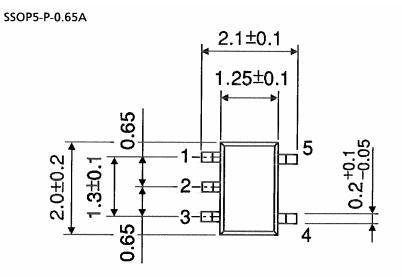


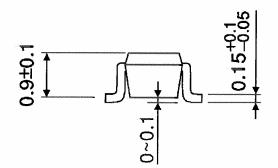


Weight: 0.016 g (typ.)

Unit : mm

Package Dimensions





Weight: 0.006 g (typ.)

Unit : mm

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